HALOGEN FREE Available



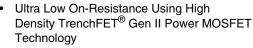


N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
20	0.0027 at $V_{GS} = 4.5 \text{ V}$	25			
	0.0042 at V _{GS} = 2.5 V	22			

FEATURES • Halogen-free According to IEC 61249-2-21

Available Ultra Low On-Resistance Using High

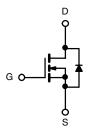




100 % R_g Tested

APPLICATIONS

- · Synchronous Rectification
- Point-Of-Load



N-Channel MOSFET

	SO-8	
S 1 S 2 S 3 G 4		8 D 7 D 6 D 5 D
	Top View	

Ordering Information: Si4378DY-T1-E3 (Lead (Pb)-free)

Si4378DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unles	s otherwise n	oted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	20		V
Gate-Source Voltage		V _{GS}	± 12		
Continuous Drain Current /T 150 °C\8	T _A = 25 °C	- I _D	25	19	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		20	13	
Pulsed Drain Current (10 μs Pulse Width)		I _{DM}	70		Α
Continuous Source Current (Diode Conduction) ^a		I _S	2.9	1.3	
Avalanche Current	L = 0.1 mH	I _{AS}	40		
Mariana Barra Biratina	T _A = 25 °C	В	3.5	1.6	W
Maximum Power Dissipation ^a	T _A = 70 °C	P_{D}	2.2	1	VV
Operating Junction and Storage Temperature Rai	T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maninesses Israelian to Amelianti	t ≤ 10 s	- R _{thJA}	29	35	1	
Maximum Junction-to-Ambient ^a	Steady State		67	80	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	13	16		

a. Surface Mounted on 1" x 1" FR4 board.

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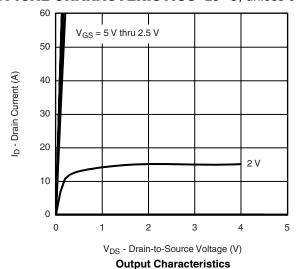
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6		1.8	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zana Oaka Valla va Busin Oamani		V _{DS} = 20 V, V _{GS} = 0 V	V _{DS} = 20 V, V _{GS} = 0 V		1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	30			Α	
5	В	$V_{GS} = 4.5 \text{ V}, I_D = 25 \text{ A}$ $V_{GS} = 2.5 \text{ V}, I_D = 22 \text{ A}$		0.0022	0.0027	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}			0.0034	0.0042		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 25 A		150		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 2.9 A, V _{GS} = 0 V		0.72	1.1	V	
Dynamic ^b			•				
Input Capacitance	C _{iss}			8500			
Output Capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		1250		pF	
Reverse Transfer Capacitance	C _{rss}			650			
Total Gate Charge	ate Charge Q _g			55			
Gate-Source Charge	Q _{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 25 \text{ A}$		16		nC	
Gate-Drain Charge	Q_{gd}			10			
Gate Resistance	R_g		0.8	1.3	2.0	Ω	
Turn-On Delay Time	t _{d(on)}			85	130		
Rise Time	t _r	V_{DD} = 10 V, R_L = 10 Ω		65	100	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1 A, V_{GEN} = 4.5 V, R_g = 6 Ω		140	210		
Fall Time	t _f			50	80		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.9 A, dl/dt = 100 A/μs		50	80		

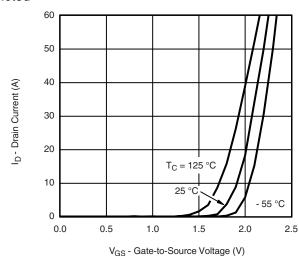
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





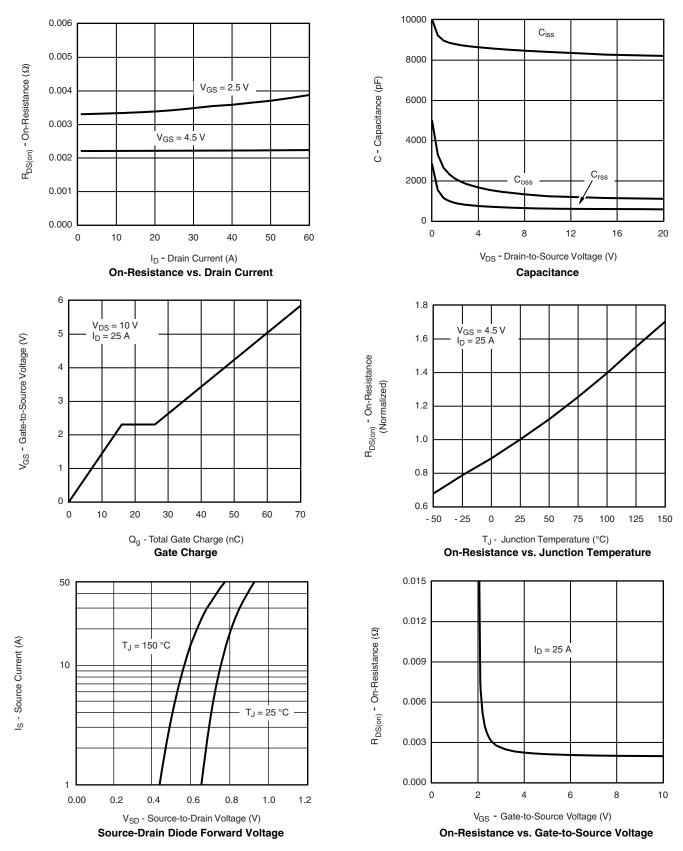
Transfer Characteristics







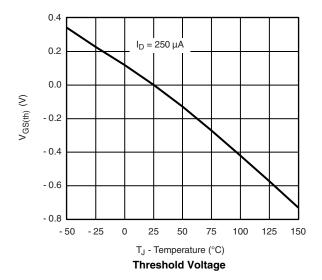
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

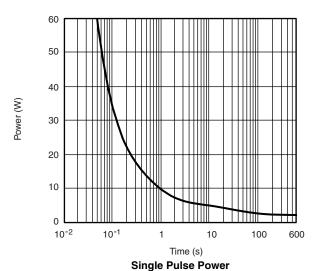


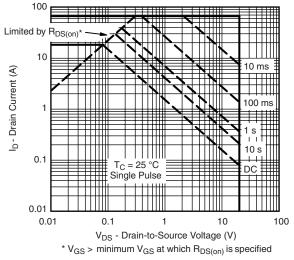
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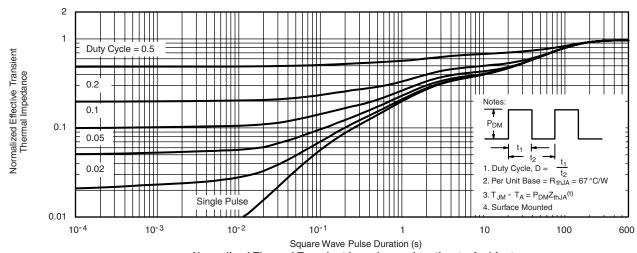
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







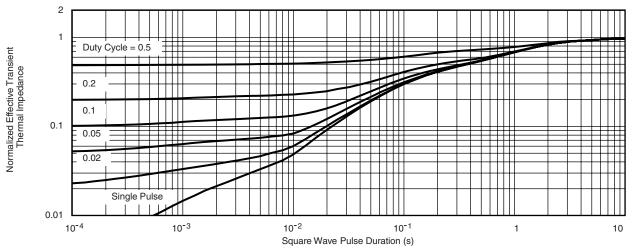




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

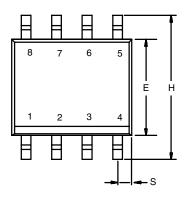


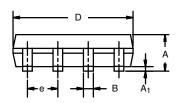
Normalized Thermal Transient Impedance, Junction-to-Foot

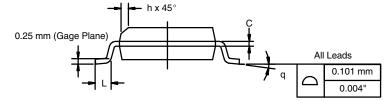
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







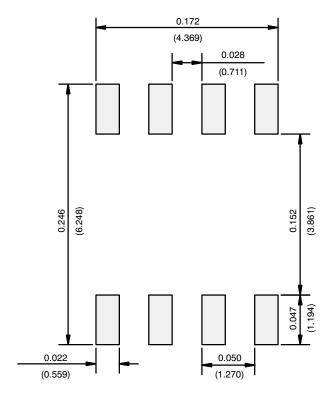
	MILLIMETERS INCHES			HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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